R SHEET



To: Honorable Commissioner of Patents and Trademarks:

Please record the attached original document(s) or copy thereof. 1. Name of conveying party(ies) **Ivor Barber** a) 2. Name and address of receiving party(ies): Name: **LSI Logic Corporation** Address: 1621 Barber Lane Milpitas, CA 95035 3. Nature of conveyance Assignment Merger Security Agreement Change of Name Other License Agreement Execution Date: April 5, 2004 10819684 4. Application Number(s) or Patent Number(s): Filed Herewith The title of the (new) application is: INTEGRATED CIRCUIT PACKAGE AND METHOD HAVING WIRE-BONDED INTRA-DIE ELECTRICAL CONNECTIONS 5. Please send all correspondence concerning this (these) documents to: **Customer Number: 24319** 6. Total number of applications and patents involved: 1 7. Total fee (37 CFR 3.41): **\$40.00** Enclosed. Charge to Deposit Account No. 12-2252 (Order No. 02-6445). Any additional fees are authorized to be charged to Deposit Account No. 12-2252 (Order No. 02-6445). aluka Date: April 6, 2004 Francis T. Kalinski II Registration No. 44,177

Total number of pages including this cover sheet, attachments and documents: 2

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02-6445/LSI1P241

(Revised 12/01)

Docket No.: 02-6445/LSI1P241 Patent

ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the undersigned, do hereby sell, assign, and transfer to: LSI LOGIC CORPORATION, a corporation of Delaware, having a place of business at 1621 Barber Lane, Milpitas, California 95035, ("Assignee"), its successors, assigns, and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all inventions and improvements which are disclosed in the application for United States Letters Patent,

				or United States Letters Patent,
(X)	which has been executed by	y the undersign	ed concurrently herew	ith,
()	which was filed on	, 20	_ and assigned Applica	tion No,
	INTEGRATED CIRC ELECTRICAL CONNE		GE AND METHO	D HAVING WIRE-BONDED
for Letters Patimprovements; States and all f	ent which have been or sha and in and to all original a	ll be filed in the and reissued pe	he United States and a atents which have be	, reissue, and all other applications all foreign countries on any of said en or shall be issued in the United priority resulting from the filing of
when requester representatives, divisional, con improvements; Assignee, its improvements assigns or repr for said improve	d, without charge to, but, to carry out in good faith the ntiming, substitute, renews execute all rightful oaths, a successors, assigns, and rand the history thereof, and resentatives shall consider de-	at the expens ne intent and pural, reissue, an assignments, po epresentatives, I generally do esirable for aid to said improve	te of, said Assignee, prose of this Assignment all other patent a owers of attorney and all facts known to everything possible witing in securing and movements and all applications.	overnents in its own name; and that, its successors, assigns and legal ent, the undersigned will execute all applications on any and all said other papers; communicate to said the undersigned relating to said hich said Assignee, its successors, aintaining proper patent protection ations to patents and all patents on tives; and
license, or other undersigned, and	er agreement affecting the ad that full right to convey th	rights and pro e same as here	perty herein conveyed in expressed is possess	
Name: Ivor Ba	arber	Date:	4/5,2004	Witness: 11-K 4/5/04

02-6445/LSI1P241

RECORDED: 04/06/2004

(Revised 011995)

Assignment

PATENT REEL: 015196 FRAME: 0588